



## Product/Process Change Notice - PCN 22\_0246 Rev. -

Analog Devices, Inc. One Analog Way, Wilmington, MA 01887, USA

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

**PCN Title:** HMC-ALH445 Die Data Sheet Limit Revision

**Publication Date:** 07-Oct-2022

**Effectivity Date:** 21-Oct-2022 *(the earliest date that a customer could expect to receive changed material)*

**Revision Description:**

Initial Release.

**Description Of Change:**

Change the thermal resistance listed in the AMR table on Page 3 from 201.2 Deg CW to 124 deg CW.

**Reason For Change:**

The data sheet is being changed to accurately reflect the device's capabilities.

**Impact of the change (positive or negative) on fit, form, function & reliability:**

No impact on fit, form, or functionality of the device.

**Summary of Supporting Information:**

Changes will be reflected in Product Data Sheet Rev v04.1022.

**Supporting Documents**

**Attachment 1: Type:** Datasheet Specification Comparison

ADI\_PCN\_22\_0246\_Rev\_-\_HMC-ALH445\_spec\_ccomparison.pdf

**For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.**

**Americas:**  
PCN\_Americas@analog.com

**Europe:**  
PCN\_Europe@analog.com

**Japan:**  
PCN\_Japan@analog.com

**Rest of Asia:**  
PCN\_ROA@analog.com

**Appendix A - Affected ADI Models**

**Added Parts On This Revision - Product Family / Model Number (1)**

HMC-ALH445G / HMC-ALH445				
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**Appendix B - Revision History**

<b>Rev</b>	<b>Publish Date</b>	<b>Effectivity Date</b>	<b>Rev Description</b>
Rev. -	07-Oct-2022	21-Oct-2022	Initial Release.

Analog Devices, Inc.

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